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# HM5112805TD-5, HM5113805TD-5

128M EDO DRAM (16-Mword × 8-bit)  
8k refresh/4k refresh

## HITACHI

ADE-203-936A (Z)  
Rev. 1.0  
June 22, 1998

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### Description

The Hitachi HM5112805 Series, HM5113805 Series are 128M-bit dynamic RAMs organized as 16,777,216-word × 8-bit. They have realized high performance and low power by employing CMOS process technology. HM5112805 Series, HM5113805 Series offer Extended Data Out (EDO) Page Mode as a high speed access mode. They are packaged in 32-pin plastic TSOPII.

### Features

- Single 3.3 V supply: 3.3 V ± 0.15 V
- Access time: 50 ns (max)
- Power dissipation
  - Active: 759 mW (max) (HM5112805 Series)  
897 mW (max) (HM5113805 Series)
  - Standby : 3.5 mW (max) (CMOS interface)
- EDO page mode capability
- Refresh cycles
  - $\overline{\text{RAS}}$ -only refresh
    - 8192 cycles/64 ms (HM5112805)
    - 4096 cycles/64 ms (HM5113805)
  - CBR/Hidden refresh
    - 4096 cycles/64 ms (HM5112805, HM5113805)

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## HM5112805TD-5, HM5113805TD-5

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- 3 variations of refresh
  - $\overline{\text{RAS}}$ -only refresh
  - $\overline{\text{CAS}}$ -before- $\overline{\text{RAS}}$  refresh
  - Hidden refresh

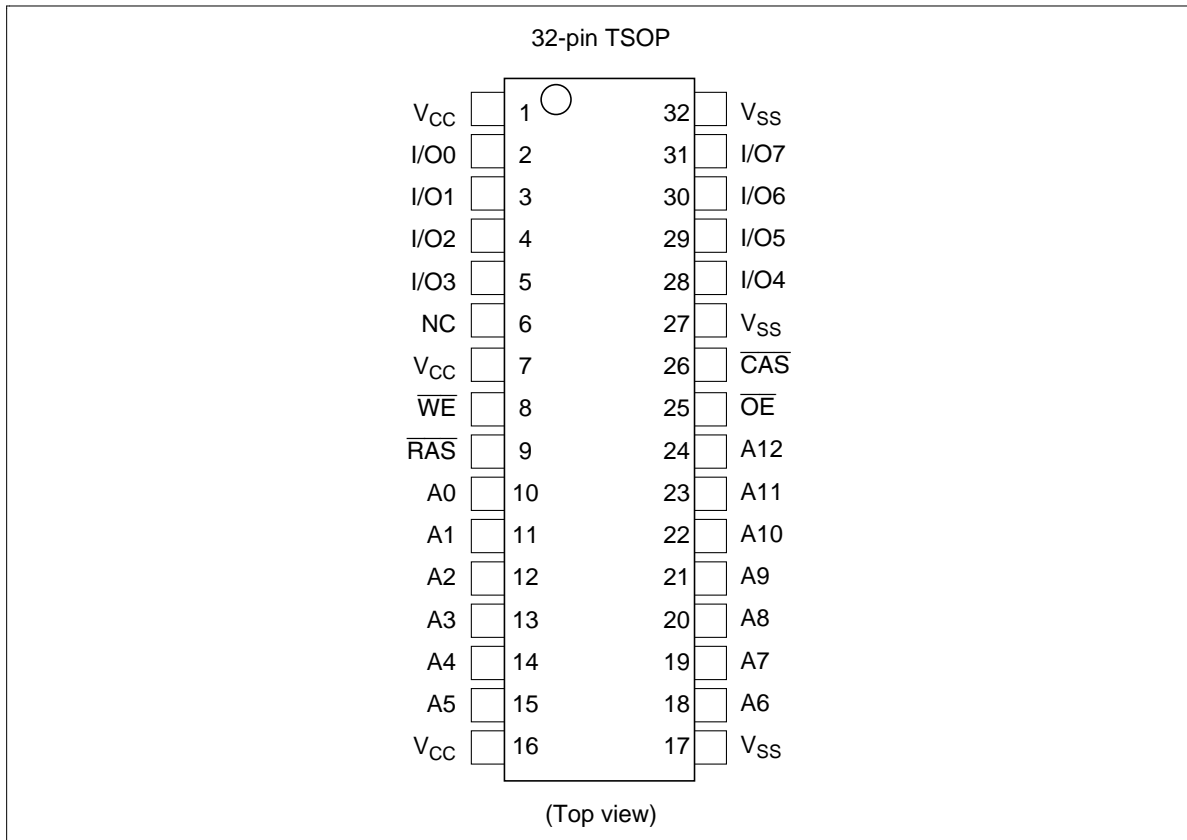
### Ordering Information

Type No.	Access time	Package
HM5112805TD-5	50 ns	400-mil 32-pin plastic TSOP II (TTP-32DF)
HM5113805TD-5	50 ns	

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## HM5112805TD-5, HM5113805TD-5

### Pin Arrangement (HM5112805 Series)

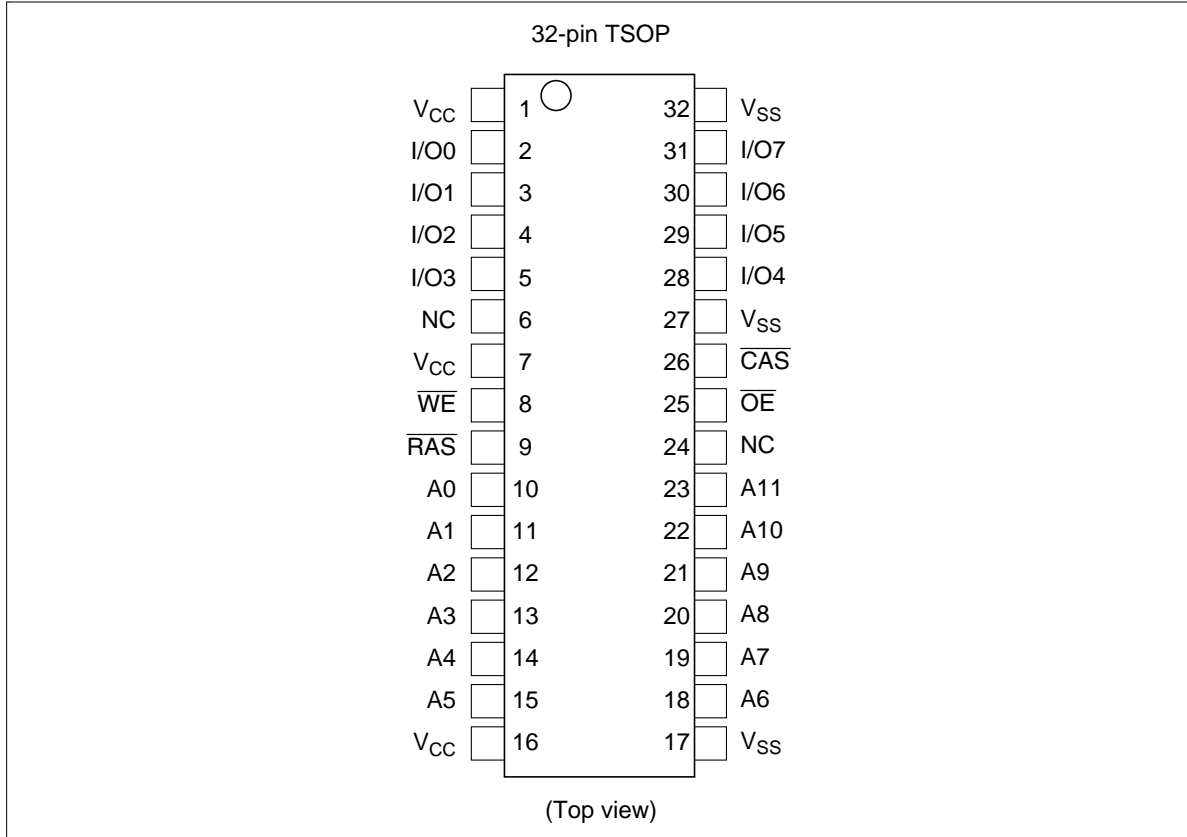


### Pin Description

Pin name	Function
A0 to A12	Address input <ul style="list-style-type: none"> <li>• Row/Refresh address A0 to A12</li> <li>• Column address A0 to A10</li> </ul>
I/O0 to I/O7	Data input/output
$\overline{\text{RAS}}$	Row address strobe
$\overline{\text{CAS}}$	Column address strobe
$\overline{\text{WE}}$	Write enable
$\overline{\text{OE}}$	Output enable
$V_{\text{cc}}$	Power supply
$V_{\text{ss}}$	Ground
NC	No connection

# HM5112805TD-5, HM5113805TD-5

## Pin Arrangement (HM5113805 Series)

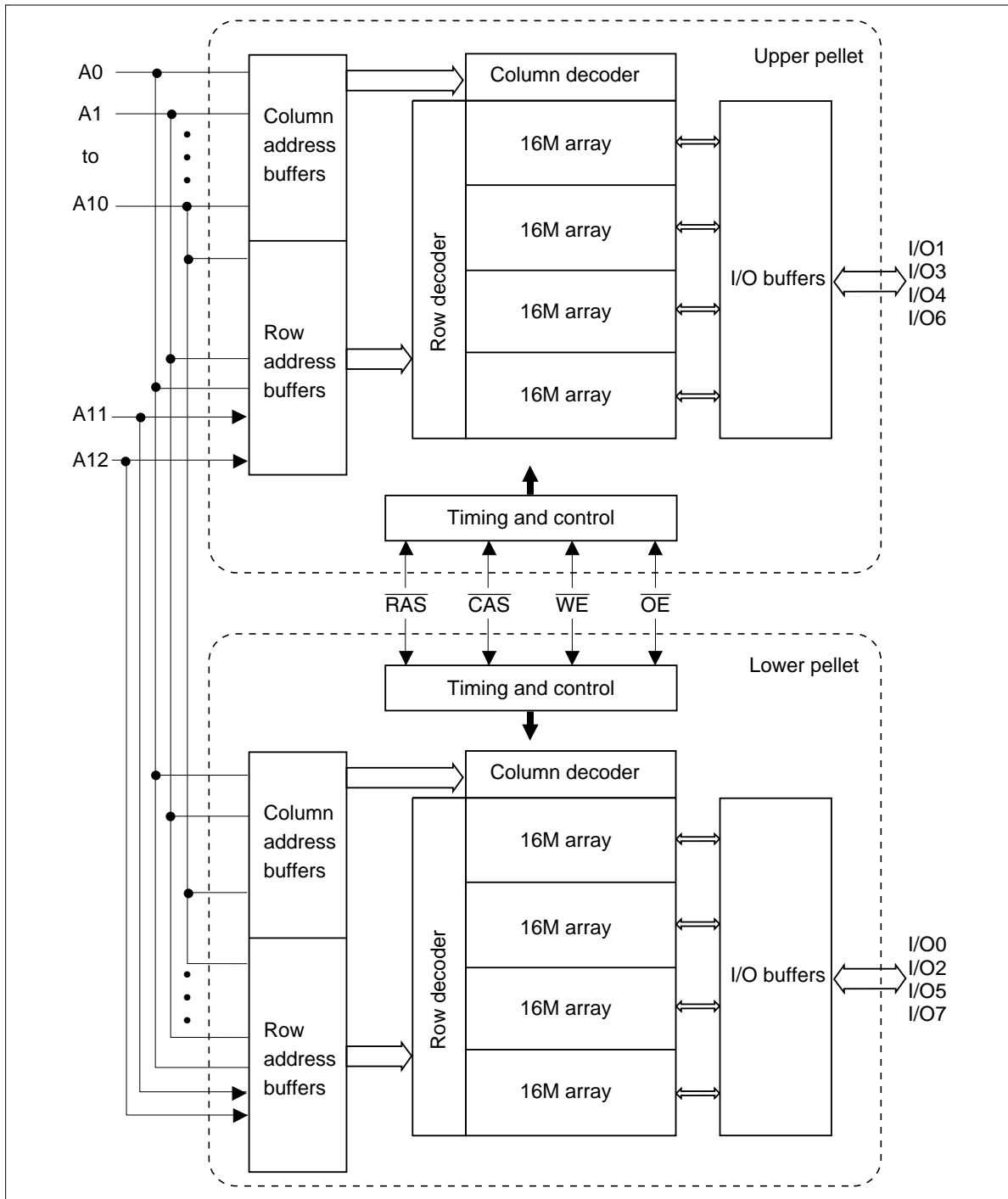


## Pin Description

Pin name	Function
A0 to A11	Address input <ul style="list-style-type: none"> <li>• Row/Refresh address A0 to A11</li> <li>• Column address A0 to A11</li> </ul>
I/O0 to I/O7	Data input/output
$\overline{\text{RAS}}$	Row address strobe
$\overline{\text{CAS}}$	Column address strobe
$\overline{\text{WE}}$	Write enable
$\overline{\text{OE}}$	Output enable
$V_{\text{CC}}$	Power supply
$V_{\text{SS}}$	Ground
NC	No connection

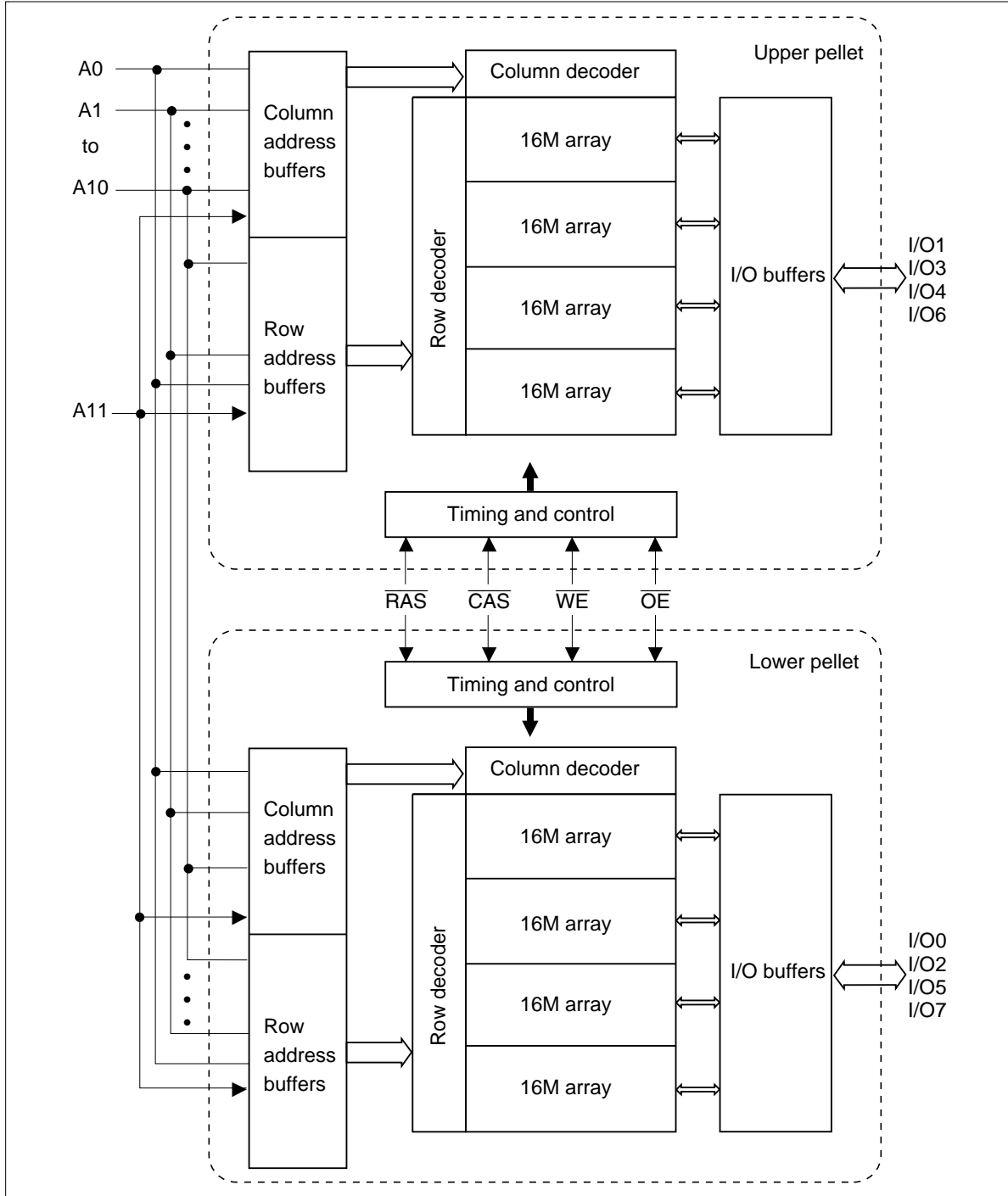
# HM5112805TD-5, HM5113805TD-5

## Block Diagram (HM5112805 Series)



# HM5112805TD-5, HM5113805TD-5

## Block Diagram (HM5113805 Series)



## HM5112805TD-5, HM5113805TD-5

### Operation Table

$\overline{\text{RAS}}$	$\overline{\text{CAS}}$	$\overline{\text{WE}}$	$\overline{\text{OE}}$	I/O 0 to I/O 7	Operation
H	×	×	×	High-Z	Standby
L	L	H	L	Dout	Read cycle
L	L	L* <sup>2</sup>	×	Din	Early write cycle
L	L	L* <sup>2</sup>	H	Din	Delayed write cycle
L	L	H to L	L to H	Dout/Din	Read-modify-write cycle
L	H	×	×	High-Z	$\overline{\text{RAS}}$ -only refresh cycle
H to L	L	H	×	High-Z	$\overline{\text{CAS}}$ -before- $\overline{\text{RAS}}$ refresh cycle
L	L	H	H	High-Z	Read cycle (Output disabled)

Notes: 1. H:  $V_{IH}$  (inactive), L:  $V_{IL}$  (active), ×:  $V_{IH}$  or  $V_{IL}$   
 2.  $t_{WCS} \geq 0$  ns: Early write cycle  
 $t_{WCS} < 0$  ns: Delayed write cycle

### Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Terminal voltage on any pin relative to $V_{SS}$	$V_T$	-0.5 to $V_{CC} + 0.5$ ( $\leq 4.6$ V (max))	V
Power supply voltage relative to $V_{SS}$	$V_{CC}$	-0.5 to +4.6	V
Short circuit output current	$I_{out}$	50	mA
Power dissipation	$P_T$	1.0	W
Storage temperature	Tstg	-55 to +125	°C

### DC Operating Conditions

Parameter	Symbol	Min	Typ	Max	Unit	Notes
Supply voltage	$V_{CC}$	3.15	3.3	3.45	V	1, 2
	$V_{SS}$	0	0	0	V	2
Input high voltage	$V_{IH}$	2.0	—	$V_{CC} + 0.3$	V	1
Input low voltage	$V_{IL}$	-0.3	—	0.8	V	1
Ambient temperature range	Ta	0	—	70	°C	

Notes: 1. All voltage referred to  $V_{SS}$ .  
 2. The supply voltage with all  $V_{CC}$  pins must be on the same level. The supply voltage with all  $V_{SS}$  pins must be on the same level.

## HM5112805TD-5, HM5113805TD-5

### DC Characteristics (HM5112805 Series)

Parameter	Symbol	HM5112805		Unit	Test conditions
		Min	Max		
Operating current <sup>*1, *2</sup>	$I_{CC1}$	—	220	mA	$t_{RC} = \text{min}$
Standby current	$I_{CC2}$	—	4	mA	TTL interface $\overline{RAS}, \overline{CAS} = V_{IH}$ Dout = High-Z
		—	1	mA	CMOS interface $\overline{RAS}, \overline{CAS} \geq V_{CC} - 0.2 \text{ V}$ Dout = High-Z
$\overline{RAS}$ -only refresh current <sup>*2</sup>	$I_{CC3}$	—	220	mA	$t_{RC} = \text{min}$
Standby current <sup>*1</sup>	$I_{CC5}$	—	10	mA	$\overline{RAS} = V_{IH}, \overline{CAS} = V_{IL}$ Dout = enable
$\overline{CAS}$ -before- $\overline{RAS}$ refresh current	$I_{CC6}$	—	220	mA	$t_{RC} = \text{min}$
EDO page mode current <sup>*1, *3</sup>	$I_{CC7}$	—	220	mA	$\overline{RAS} = V_{IL}, \overline{CAS}$ cycle, $t_{HPC} = t_{HPC} \text{ min}$
Input leakage current	$I_{LI}$	-5	5	$\mu\text{A}$	$0 \text{ V} \leq V_{in} \leq V_{CC} + 0.3 \text{ V}$
Output leakage current	$I_{LO}$	-5	5	$\mu\text{A}$	$0 \text{ V} \leq V_{out} \leq V_{CC}$ Dout = disable
Output high voltage	$V_{OH}$	2.4	$V_{CC}$	V	High Iout = -2 mA
Output low voltage	$V_{OL}$	0	0.4	V	Low Iout = 2 mA

Notes: 1.  $I_{CC}$  depends on output load condition when the device is selected.  $I_{CC}$  max is specified at the output open condition.

2. Address can be changed once or less while  $\overline{RAS} = V_{IL}$ .

3. Measured with one sequential address change per EDO cycle,  $t_{HPC}$ .

## HM5112805TD-5, HM5113805TD-5

### DC Characteristics (HM5113805 Series)

Parameter	Symbol	HM5113805		Unit	Test conditions
		Min	Max		
Operating current* <sup>1, *2</sup>	$I_{CC1}$	—	260	mA	$t_{RC} = \text{min}$
Standby current	$I_{CC2}$	—	4	mA	TTL interface $\overline{RAS}, \overline{CAS} = V_{IH}$ Dout = High-Z
		—	1	mA	CMOS interface $\overline{RAS}, \overline{CAS} \geq V_{CC} - 0.2 \text{ V}$ Dout = High-Z
$\overline{RAS}$ -only refresh current* <sup>2</sup>	$I_{CC3}$	—	260	mA	$t_{RC} = \text{min}$
Standby current* <sup>1</sup>	$I_{CC5}$	—	10	mA	$\overline{RAS} = V_{IH}, \overline{CAS} = V_{IL}$ Dout = enable
$\overline{CAS}$ -before- $\overline{RAS}$ refresh current	$I_{CC6}$	—	260	mA	$t_{RC} = \text{min}$
EDO page mode current* <sup>1, *3</sup>	$I_{CC7}$	—	220	mA	$\overline{RAS} = V_{IL}, \overline{CAS}$ cycle, $t_{HPC} = t_{HPC} \text{ min}$
Input leakage current	$I_{LI}$	-5	5	$\mu\text{A}$	$0 \text{ V} \leq V_{in} \leq V_{CC} + 0.3 \text{ V}$
Output leakage current	$I_{LO}$	-5	5	$\mu\text{A}$	$0 \text{ V} \leq V_{out} \leq V_{CC}$ Dout = disable
Output high voltage	$V_{OH}$	2.4	$V_{CC}$	V	High Iout = -2 mA
Output low voltage	$V_{OL}$	0	0.4	V	Low Iout = 2 mA

- Notes: 1.  $I_{CC}$  depends on output load condition when the device is selected.  $I_{CC}$  max is specified at the output open condition.  
 2. Address can be changed once or less while  $\overline{RAS} = V_{IL}$ .  
 3. Measured with one sequential address change per EDO cycle,  $t_{HPC}$ .

### Capacitance ( $T_a = 25^\circ\text{C}$ , $V_{CC} = 3.3 \text{ V} \pm 0.15 \text{ V}$ )

Parameter	Symbol	Typ	Max	Unit	Notes
Input capacitance (Address)	$C_{I1}$	—	7	pF	1
Input capacitance (Clocks)	$C_{I2}$	—	7	pF	1
Output capacitance (Data-in, Data-out)	$C_{I/O}$	—	8	pF	1, 2

- Notes : 1. Capacitance measured with Boonton Meter or effective capacitance measuring method.  
 2.  $\overline{RAS}$  and  $\overline{CAS} = V_{IH}$  to disable Dout.

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**AC Characteristics** ( $T_a = 0$  to  $+70^\circ\text{C}$ ,  $V_{CC} = 3.3\text{ V} \pm 0.15\text{ V}$ ,  $V_{SS} = 0\text{ V}$ ) \*<sup>1</sup>, \*<sup>2</sup>, \*<sup>19</sup>

### Test Conditions

- Input rise and fall time: 2 ns
- Input pulse levels:  $V_{IL} = 0\text{ V}$ ,  $V_{IH} = 3.0\text{ V}$
- Input timing reference levels: 0.8 V, 2.0 V
- Output timing reference levels: 0.8 V, 2.0 V
- Output load: 1 TTL gate +  $C_L$  (100 pF) (Including scope and jig)

### Read, Write, Read-Modify-Write and Refresh Cycles (Common parameters)

Parameter	Symbol	HM5112805/HM5113805		Unit	Notes
		Min	Max		
Random read or write cycle time	$t_{RC}$	84	—	ns	
$\overline{\text{RAS}}$ precharge time	$t_{RP}$	30	—	ns	
$\overline{\text{CAS}}$ precharge time	$t_{CP}$	8	—	ns	
$\overline{\text{RAS}}$ pulse width	$t_{RAS}$	50	10000	ns	
$\overline{\text{CAS}}$ pulse width	$t_{CAS}$	8	10000	ns	
Row address setup time	$t_{ASR}$	0	—	ns	
Row address hold time	$t_{RAH}$	8	—	ns	
Column address setup time	$t_{ASC}$	0	—	ns	
Column address hold time	$t_{CAH}$	8	—	ns	
$\overline{\text{RAS}}$ to $\overline{\text{CAS}}$ delay time	$t_{RCD}$	12	37	ns	3
$\overline{\text{RAS}}$ to column address delay time	$t_{RAD}$	10	25	ns	4
$\overline{\text{RAS}}$ hold time	$t_{RSH}$	13	—	ns	
$\overline{\text{CAS}}$ hold time	$t_{CSH}$	35	—	ns	
$\overline{\text{CAS}}$ to $\overline{\text{RAS}}$ precharge time	$t_{CRP}$	5	—	ns	
$\overline{\text{OE}}$ to $D_{in}$ delay time	$t_{OED}$	13	—	ns	5
$\overline{\text{OE}}$ delay time from $D_{in}$	$t_{DZO}$	0	—	ns	6
$\overline{\text{CAS}}$ delay time from $D_{in}$	$t_{DZC}$	0	—	ns	6
Transition time (rise and fall)	$t_T$	2	50	ns	7

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### Read Cycle

Parameter	Symbol	HM5112805/HM5113805		Unit	Notes
		-5			
		Min	Max		
Access time from $\overline{\text{RAS}}$	$t_{\text{RAC}}$	—	50	ns	8, 9
Access time from $\overline{\text{CAS}}$	$t_{\text{CAC}}$	—	13	ns	9, 10, 17
Access time from address	$t_{\text{AA}}$	—	25	ns	9, 11, 17
Access time from $\overline{\text{OE}}$	$t_{\text{OEA}}$	—	13	ns	9
Read command setup time	$t_{\text{RCS}}$	0	—	ns	
Read command hold time to $\overline{\text{CAS}}$	$t_{\text{RCH}}$	0	—	ns	12
Read command hold time from $\overline{\text{RAS}}$	$t_{\text{RCHR}}$	50	—	ns	
Read command hold time to $\overline{\text{RAS}}$	$t_{\text{RRH}}$	0	—	ns	12
Column address to $\overline{\text{RAS}}$ lead time	$t_{\text{RAL}}$	25	—	ns	
Column address to $\overline{\text{CAS}}$ lead time	$t_{\text{CAL}}$	15	—	ns	
$\overline{\text{CAS}}$ to output in low-Z	$t_{\text{CLZ}}$	0	—	ns	
Output data hold time	$t_{\text{OH}}$	3	—	ns	21
Output data hold time from $\overline{\text{OE}}$	$t_{\text{OHO}}$	3	—	ns	
Output buffer turn-off time	$t_{\text{OFF}}$	—	13	ns	13, 21
Output buffer turn-off to $\overline{\text{OE}}$	$t_{\text{OEZ}}$	—	13	ns	13
$\overline{\text{CAS}}$ to Din delay time	$t_{\text{CDD}}$	13	—	ns	5
Output data hold time from $\overline{\text{RAS}}$	$t_{\text{OHR}}$	3	—	ns	21
Output buffer turn-off to $\overline{\text{RAS}}$	$t_{\text{OFR}}$	—	13	ns	13, 21
Output buffer turn-off to $\overline{\text{WE}}$	$t_{\text{WEZ}}$	—	13	ns	13
$\overline{\text{WE}}$ to Din delay time	$t_{\text{WED}}$	13	—	ns	
$\overline{\text{RAS}}$ to Din delay time	$t_{\text{RDD}}$	13	—	ns	

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### Write Cycle

		HM5112805/HM5113805			
		-5			
Parameter	Symbol	Min	Max	Unit	Notes
Write command setup time	$t_{WCS}$	0	—	ns	14
Write command hold time	$t_{WCH}$	8	—	ns	
Write command pulse width	$t_{WP}$	8	—	ns	
Write command to $\overline{RAS}$ lead time	$t_{RWL}$	13	—	ns	
Write command to $\overline{CAS}$ lead time	$t_{CWL}$	8	—	ns	
Data-in setup time	$t_{DS}$	0	—	ns	15
Data-in hold time	$t_{DH}$	8	—	ns	15

### Read-Modify-Write Cycle

		HM5112805/HM5113805			
		-5			
Parameter	Symbol	Min	Max	Unit	Notes
Read-modify-write cycle time	$t_{RWC}$	116	—	ns	
$\overline{RAS}$ to $\overline{WE}$ delay time	$t_{RWD}$	67	—	ns	14
$\overline{CAS}$ to $\overline{WE}$ delay time	$t_{CWD}$	30	—	ns	14
Column address to $\overline{WE}$ delay time	$t_{AWD}$	42	—	ns	14
$\overline{OE}$ hold time from $\overline{WE}$	$t_{OEh}$	13	—	ns	

### Refresh Cycle

		HM5112805/HM5113805			
		-5			
Parameter	Symbol	Min	Max	Unit	Notes
$\overline{CAS}$ setup time (CBR refresh cycle)	$t_{CSR}$	5	—	ns	
$\overline{CAS}$ hold time (CBR refresh cycle)	$t_{CHR}$	8	—	ns	
$\overline{WE}$ setup time (CBR refresh cycle)	$t_{WRP}$	0	—	ns	
$\overline{WE}$ hold time (CBR refresh cycle)	$t_{WRH}$	8	—	ns	
$\overline{RAS}$ precharge to $\overline{CAS}$ hold time	$t_{RPC}$	5	—	ns	

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### EDO Page Mode Cycle

Parameter	Symbol	HM5112805/HM5113805		Unit	Notes
		-5			
		Min	Max		
EDO page mode cycle time	$t_{HPC}$	20	—	ns	20
EDO page mode $\overline{RAS}$ pulse width	$t_{RASP}$	—	100000	ns	16
Access time from $\overline{CAS}$ precharge	$t_{CPA}$	—	28	ns	9, 17
$\overline{RAS}$ hold time from $\overline{CAS}$ precharge	$t_{CPRH}$	28	—	ns	
Output data hold time from $\overline{CAS}$ low	$t_{DOH}$	3	—	ns	9, 22
$\overline{CAS}$ hold time referred $\overline{OE}$	$t_{COL}$	8	—	ns	
$\overline{CAS}$ to $\overline{OE}$ setup time	$t_{COP}$	5	—	ns	
Read command hold time from $\overline{CAS}$ precharge	$t_{RCHC}$	28	—	ns	
Write pulse width during $\overline{CAS}$ precharge	$t_{WPE}$	8	—	ns	
$\overline{OE}$ precharge time	$t_{OEP}$	8	—	ns	

### EDO Page Mode Read-Modify-Write Cycle

Parameter	Symbol	HM5112805/HM5113805		Unit	Notes
		-5			
		Min	Max		
EDO page mode read-modify-write cycle time	$t_{HPRWC}$	57	—	ns	
$\overline{WE}$ delay time from $\overline{CAS}$ precharge	$t_{CPW}$	45	—	ns	14

### Refresh(HM5112805 Series)

Parameter	Symbol	Max	Unit	Notes
Refresh period	$t_{REF}$	64	ms	8192 cycles

### Refresh(HM5113805 Series)

Parameter	Symbol	Max	Unit	Notes
Refresh period	$t_{REF}$	64	ms	4096 cycles

Notes: 1. AC measurements assume  $t_r = 2$  ns.

2. An initial pause of 200  $\mu$ s is required after power up followed by a minimum of eight initialization cycles (any combination of cycles containing RAS-only refresh or CAS-before-RAS refresh).

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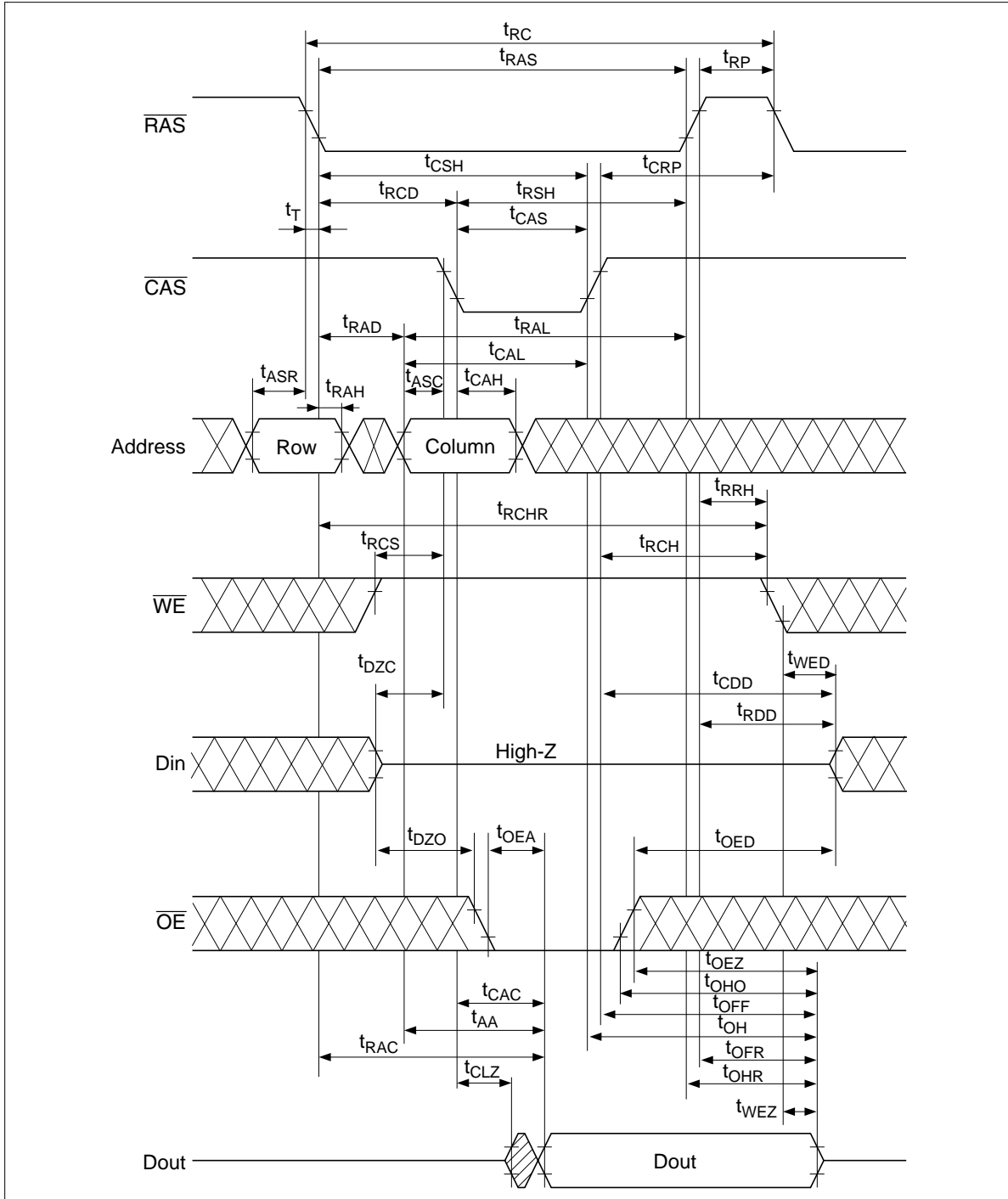
## HM5112805TD-5, HM5113805TD-5

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3. Operation with the  $t_{\text{RCD}}$  (max) limit insures that  $t_{\text{RAC}}$  (max) can be met,  $t_{\text{RCD}}$  (max) is specified as a reference point only; if  $t_{\text{RCD}}$  is greater than the specified  $t_{\text{RCD}}$  (max) limit, then the access time is controlled exclusively by  $t_{\text{CAC}}$ .
4. Operation with the  $t_{\text{RAD}}$  (max) limit insures that  $t_{\text{RAC}}$  (max) can be met,  $t_{\text{RAD}}$  (max) is specified as a reference point only; if  $t_{\text{RAD}}$  is greater than the specified  $t_{\text{RAD}}$  (max) limit, then access time is controlled exclusively by  $t_{\text{AA}}$ .
5. Either  $t_{\text{OED}}$  or  $t_{\text{CDD}}$  must be satisfied.
6. Either  $t_{\text{DZO}}$  or  $t_{\text{DZC}}$  must be satisfied.
7.  $V_{\text{IH}}$  (min) and  $V_{\text{IL}}$  (max) are reference levels for measuring timing of input signals. Also, transition times are measured between  $V_{\text{IH}}$  (min) and  $V_{\text{IL}}$  (max).
8. Assumes that  $t_{\text{RCD}} \leq t_{\text{RCD}}$  (max) and  $t_{\text{RAD}} \leq t_{\text{RAD}}$  (max). If  $t_{\text{RCD}}$  or  $t_{\text{RAD}}$  is greater than the maximum recommended value shown in this table,  $t_{\text{RAC}}$  exceeds the value shown.
9. Measured with a load circuit equivalent to 1 TTL loads and 100 pF.
10. Assumes that  $t_{\text{RCD}} \geq t_{\text{RCD}}$  (max) and  $t_{\text{RCD}} + t_{\text{CAC}}$  (max)  $\geq t_{\text{RAD}} + t_{\text{AA}}$  (max).
11. Assumes that  $t_{\text{RAD}} \geq t_{\text{RAD}}$  (max) and  $t_{\text{RCD}} + t_{\text{CAC}}$  (max)  $\leq t_{\text{RAD}} + t_{\text{AA}}$  (max).
12. Either  $t_{\text{RCH}}$  or  $t_{\text{RRH}}$  must be satisfied for a read cycles.
13.  $t_{\text{OFF}}$  (max),  $t_{\text{OEZ}}$  (max),  $t_{\text{WEZ}}$  (max) and  $t_{\text{OFR}}$  (max) define the time at which the outputs achieve the open circuit condition and are not referred to output voltage levels.
14.  $t_{\text{WCS}}$ ,  $t_{\text{RWD}}$ ,  $t_{\text{CWD}}$ ,  $t_{\text{AWD}}$  and  $t_{\text{CPW}}$  are not restrictive operating parameters. They are included in the data sheet as electrical characteristics only; if  $t_{\text{WCS}} \geq t_{\text{WCS}}$  (min), the cycle is an early write cycle and the data out pin will remain open circuit (high impedance) throughout the entire cycle; if  $t_{\text{RWD}} \geq t_{\text{RWD}}$  (min),  $t_{\text{CWD}} \geq t_{\text{CWD}}$  (min), and  $t_{\text{AWD}} \geq t_{\text{AWD}}$  (min), or  $t_{\text{CWD}} \geq t_{\text{CWD}}$  (min),  $t_{\text{AWD}} \geq t_{\text{AWD}}$  (min) and  $t_{\text{CPW}} \geq t_{\text{CPW}}$  (min), the cycle is a read-modify-write and the data output will contain data read from the selected cell; if neither of the above sets of conditions is satisfied, the condition of the data out (at access time) is indeterminate.
15.  $t_{\text{DS}}$  and  $t_{\text{DH}}$  are referred to  $\overline{\text{CAS}}$  leading edge in early write cycles and to  $\overline{\text{WE}}$  leading edge in delayed write or read-modify-write cycles.
16.  $t_{\text{RASP}}$  defines  $\overline{\text{RAS}}$  pulse width in EDO page mode cycles.
17. Access time is determined by the longest among  $t_{\text{AA}}$ ,  $t_{\text{CAC}}$  and  $t_{\text{CPA}}$ .
18. In delayed write or read-modify-write cycles,  $\overline{\text{OE}}$  must disable output buffer prior to applying data to the device.
19. When output buffers are enabled once, sustain the low impedance state until valid data is obtained. When output buffer is turned on and off within a very short time, generally it causes large  $V_{\text{CC}}/V_{\text{SS}}$  line noise, which causes to degrade  $V_{\text{IH}}$  min/ $V_{\text{IL}}$  max level.
20.  $t_{\text{HPC}}$  (min) can be achieved during a series of EDO page mode write cycles or EDO page mode read cycles. If both write and read operation are mixed in a EDO page mode  $\overline{\text{RAS}}$  cycle (EDO page mode mix cycle (1), (2)), minimum value of  $\overline{\text{CAS}}$  cycle ( $t_{\text{CAS}} + t_{\text{CP}} + 2 t_{\text{r}}$ ) becomes greater than the specified  $t_{\text{HPC}}$  (min) value. The value of  $\overline{\text{CAS}}$  cycle time of mixed EDO page mode is shown in EDO page mode mix cycle (1) and (2).
21. Data output turns off and becomes high impedance from later rising edge of  $\overline{\text{RAS}}$  and  $\overline{\text{CAS}}$ . Hold time and turn off time are specified by the timing specifications of later rising edge of  $\overline{\text{RAS}}$  and  $\overline{\text{CAS}}$  between  $t_{\text{OHR}}$  and  $t_{\text{OH}}$  and between  $t_{\text{OFR}}$  and  $t_{\text{OFF}}$ .
22.  $t_{\text{DOH}}$  defines the time at which the output level go cross.  $V_{\text{OL}} = 0.8 \text{ V}$ ,  $V_{\text{OH}} = 2.0 \text{ V}$  of output timing reference level.
23. XXX: H or L (H:  $V_{\text{IH}}$  (min)  $\leq V_{\text{IN}} \leq V_{\text{IH}}$  (max), L:  $V_{\text{IL}}$  (min)  $\leq V_{\text{IN}} \leq V_{\text{IL}}$  (max))  
/////: Invalid Dout  
When the address, clock and input pins are not described on timing waveforms, their pins must be applied  $V_{\text{IH}}$  or  $V_{\text{IL}}$ .

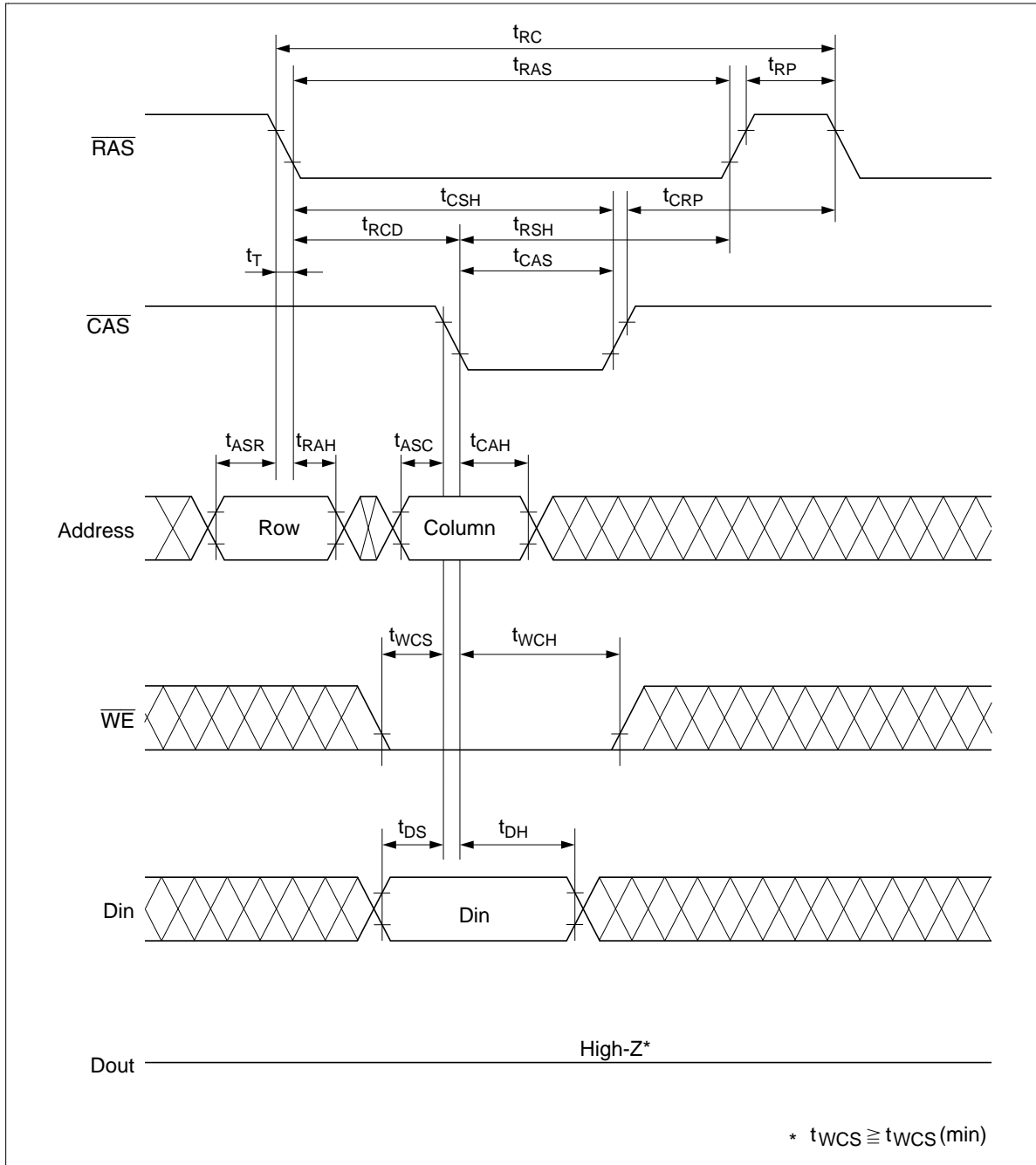
Timing Waveforms\*23

Read Cycle

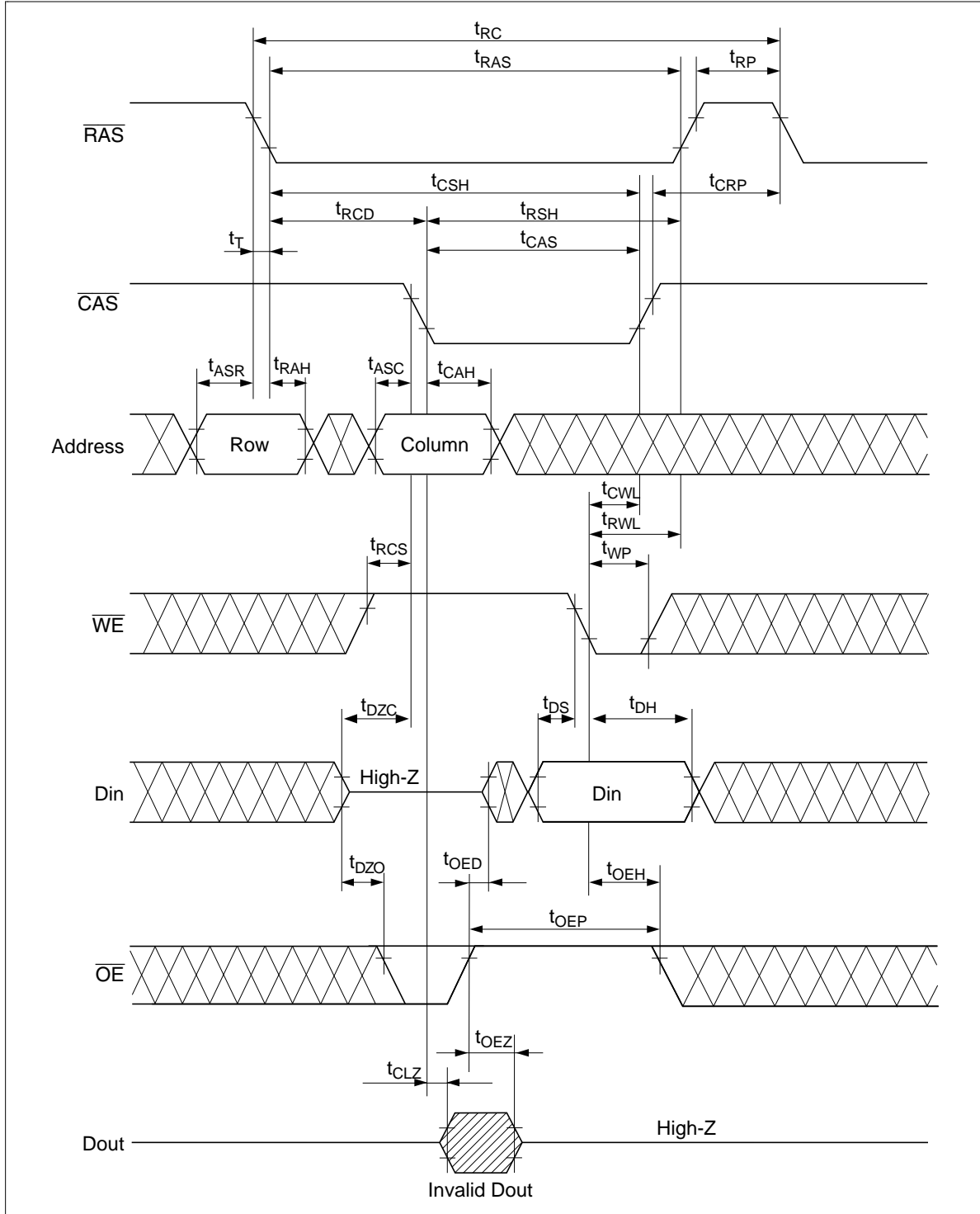


# HM5112805TD-5, HM5113805TD-5

## Early Write Cycle

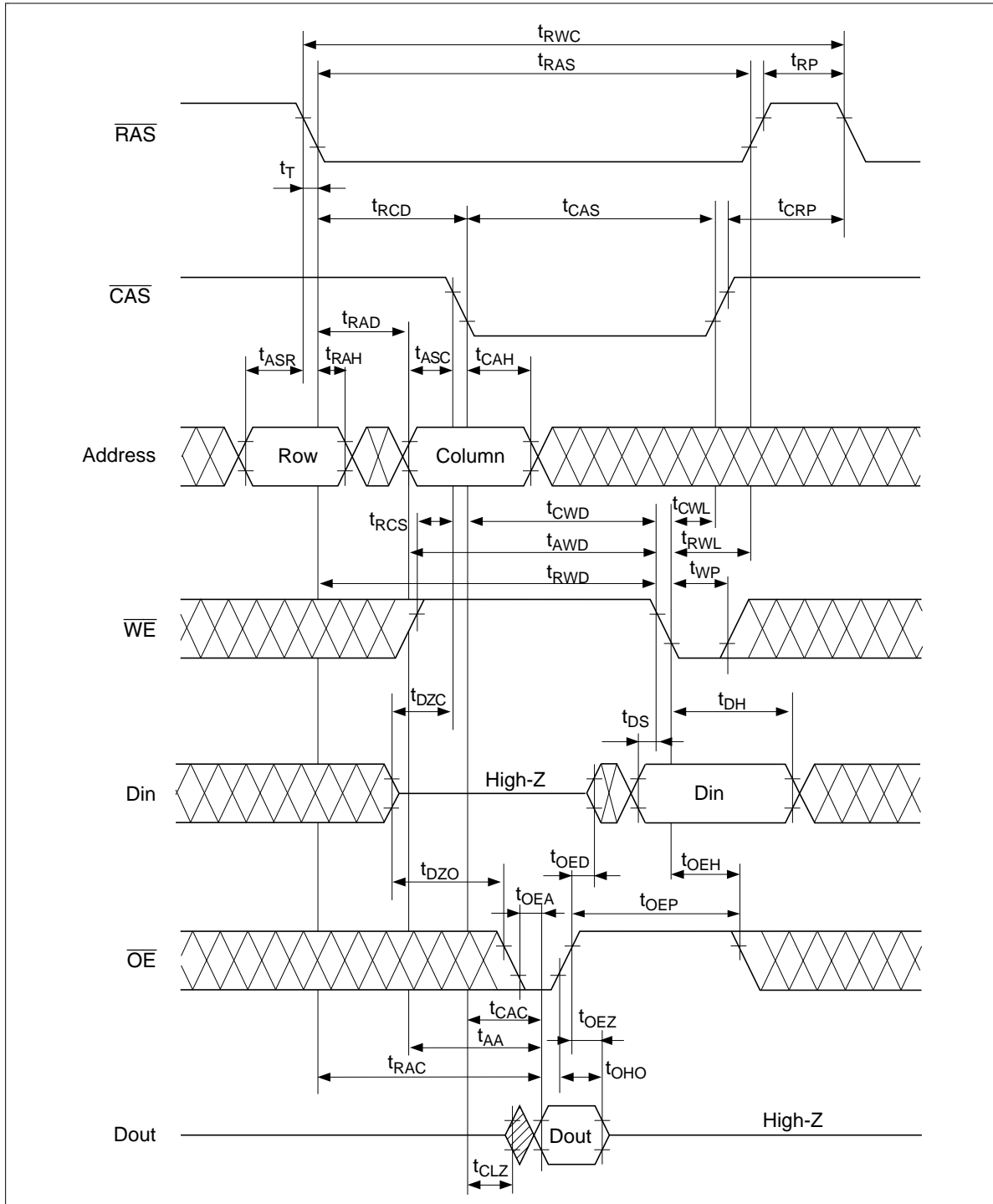


Delayed Write Cycle<sup>\*18</sup>

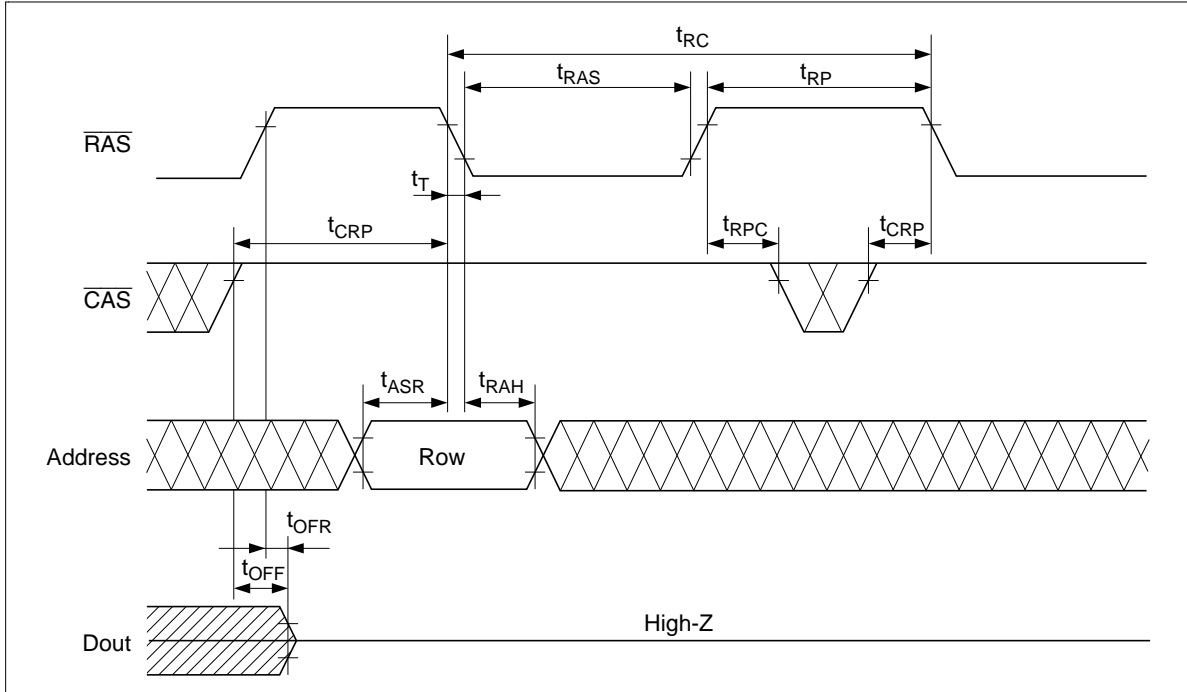


# HM5112805TD-5, HM5113805TD-5

## Read-Modify-Write Cycle\*18

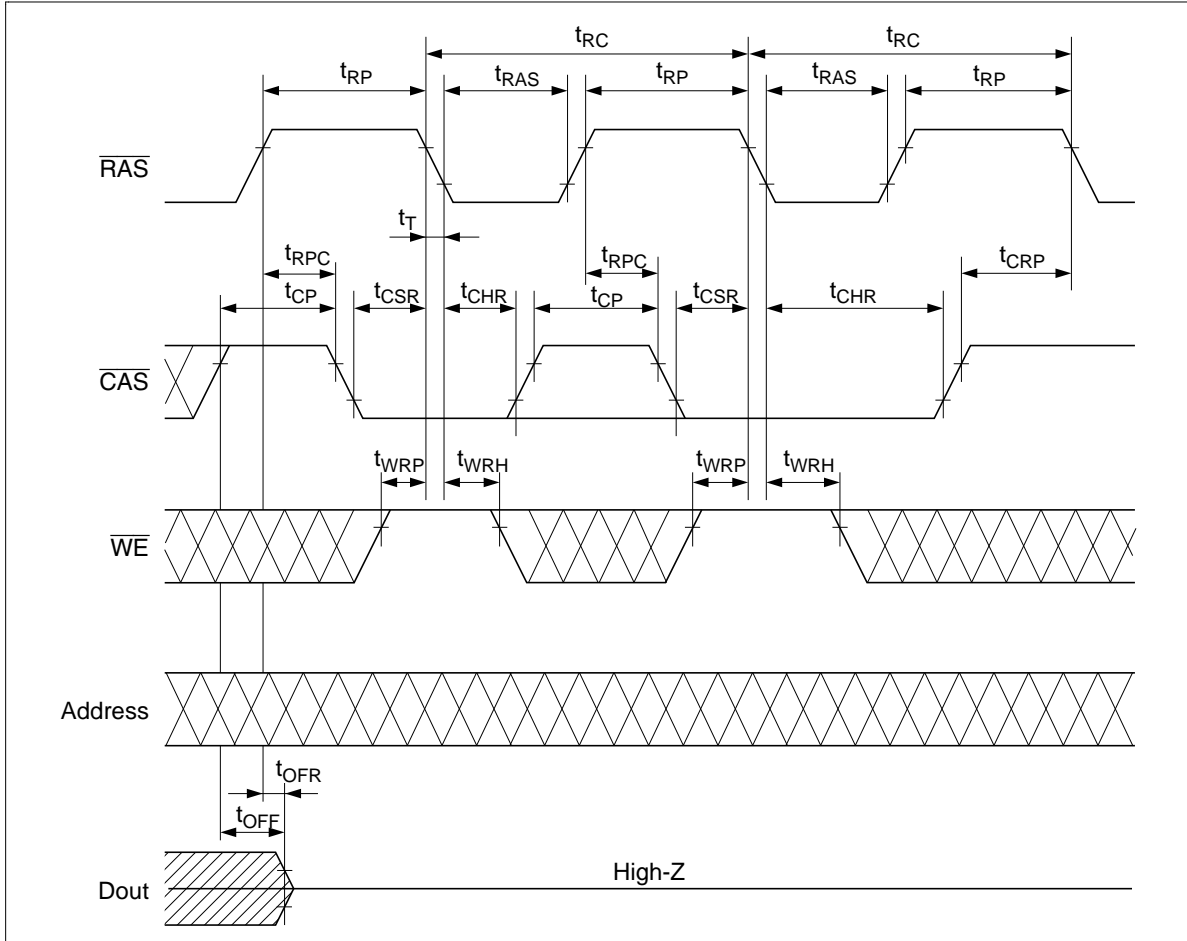


$\overline{\text{RAS}}$ -Only Refresh Cycle

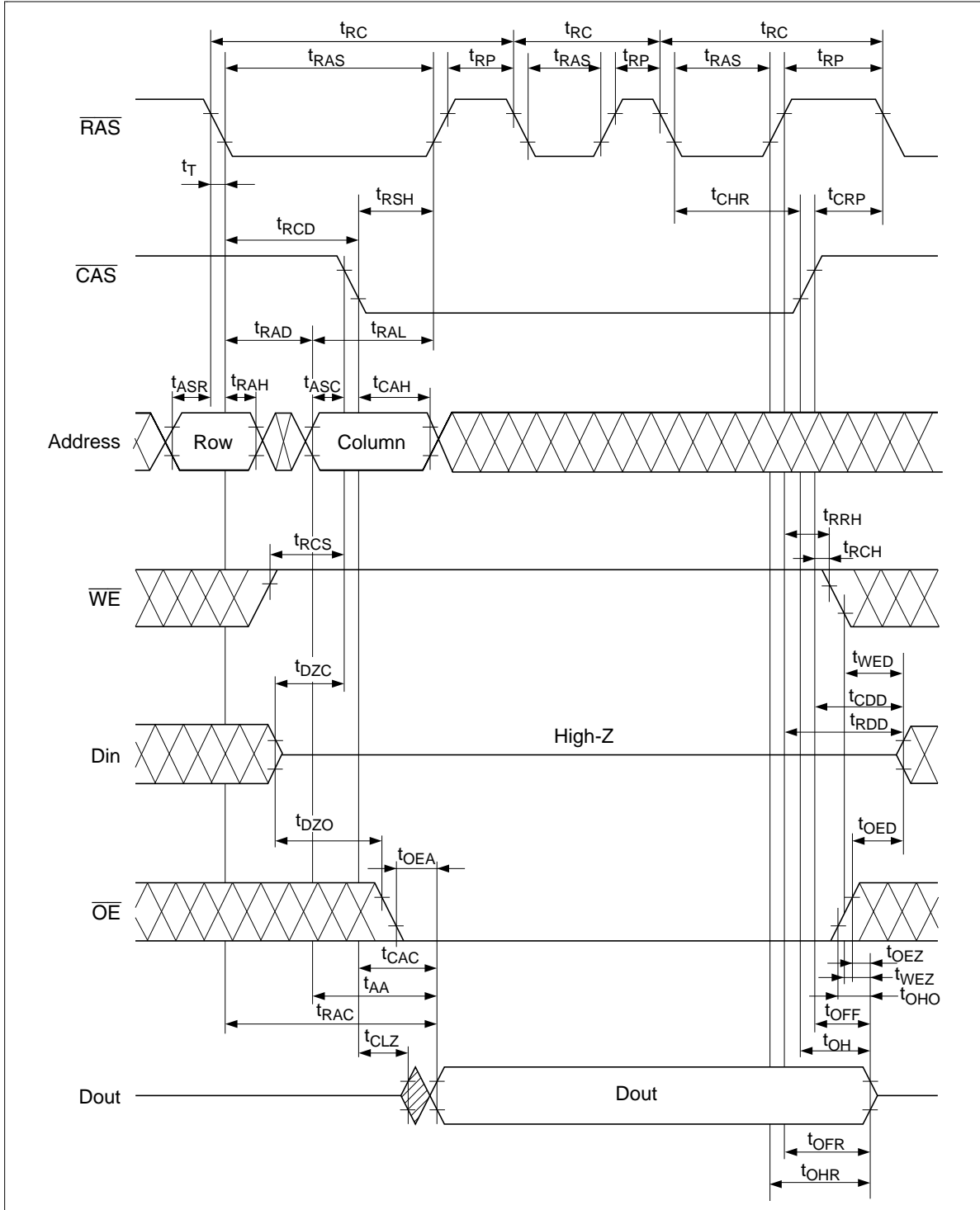


# HM5112805TD-5, HM5113805TD-5

## $\overline{\text{CAS}}$ -Before- $\overline{\text{RAS}}$ Refresh Cycle



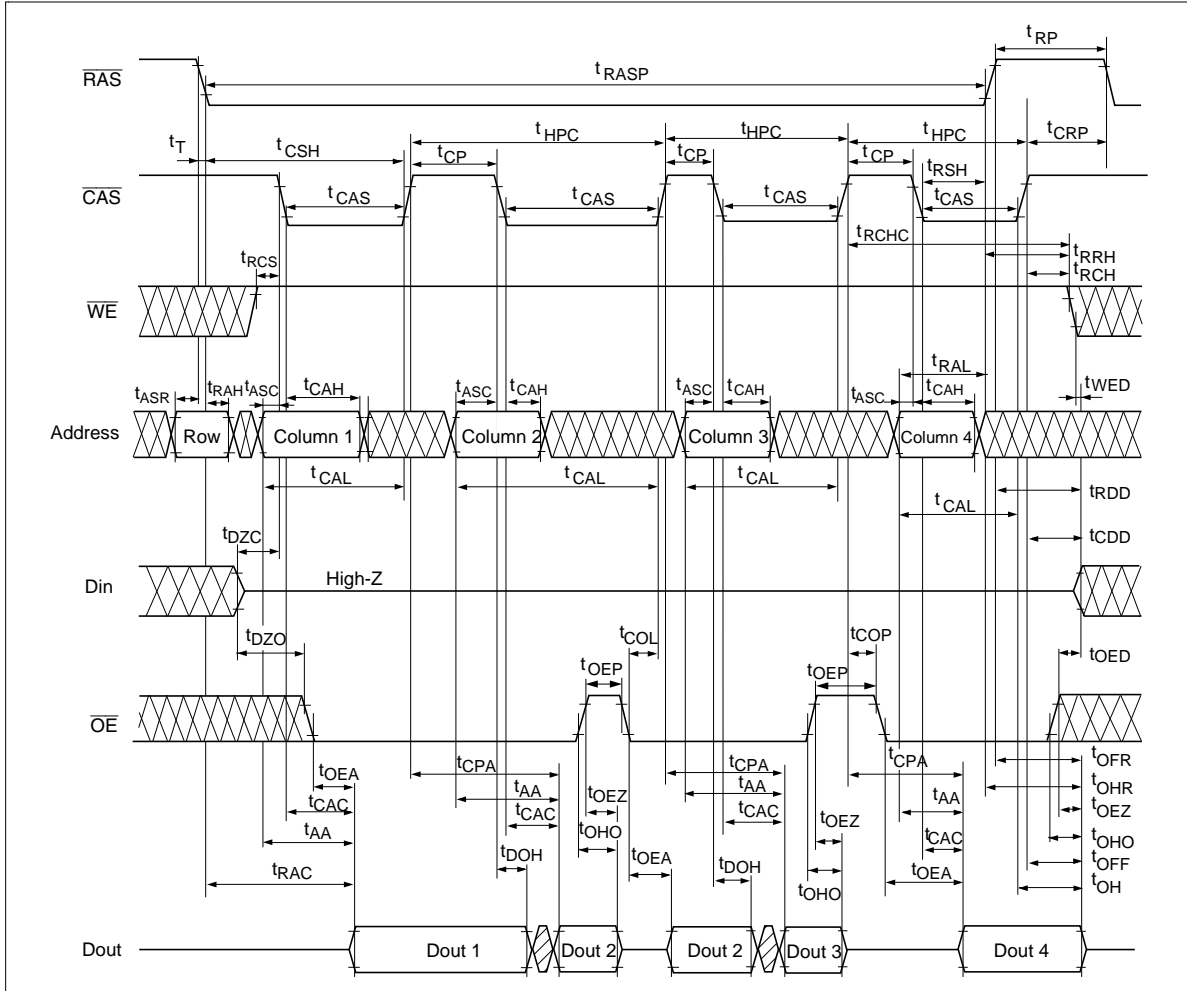
Hidden Refresh Cycle





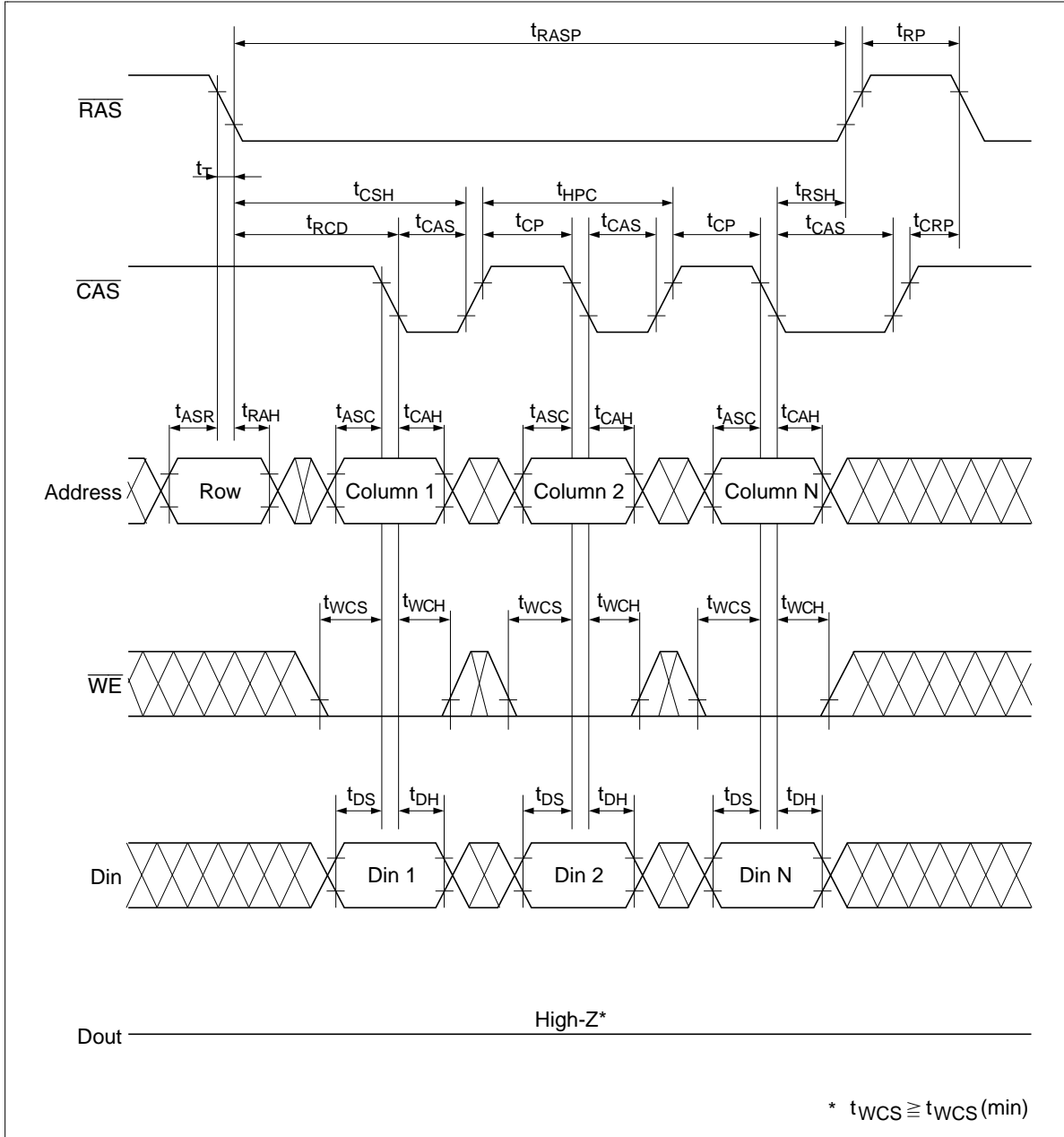
# HM5112805TD-5, HM5113805TD-5

## EDO Page Mode Read Cycle (2)



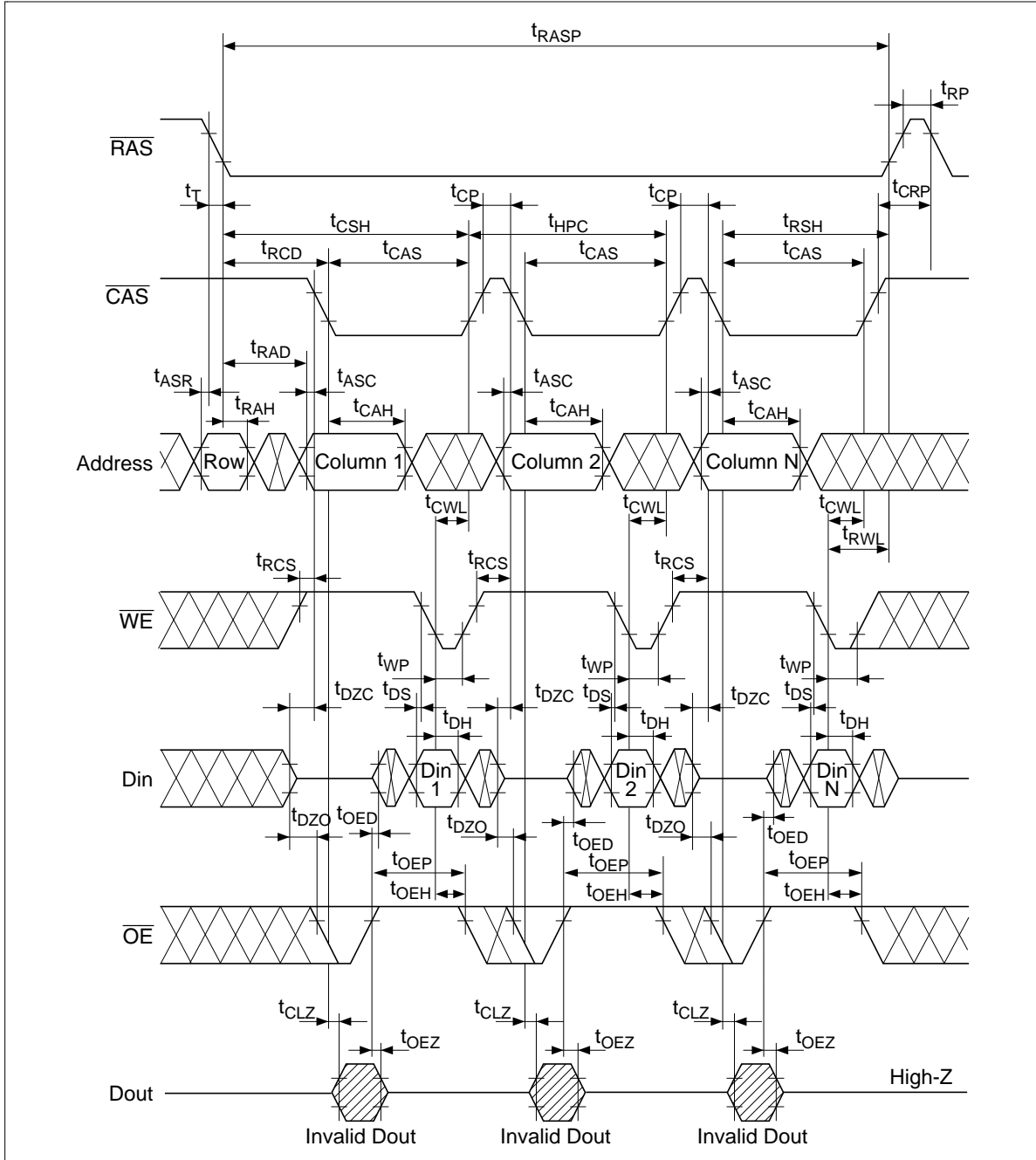
# HM5112805TD-5, HM5113805TD-5

## EDO Page Mode Early Write Cycle



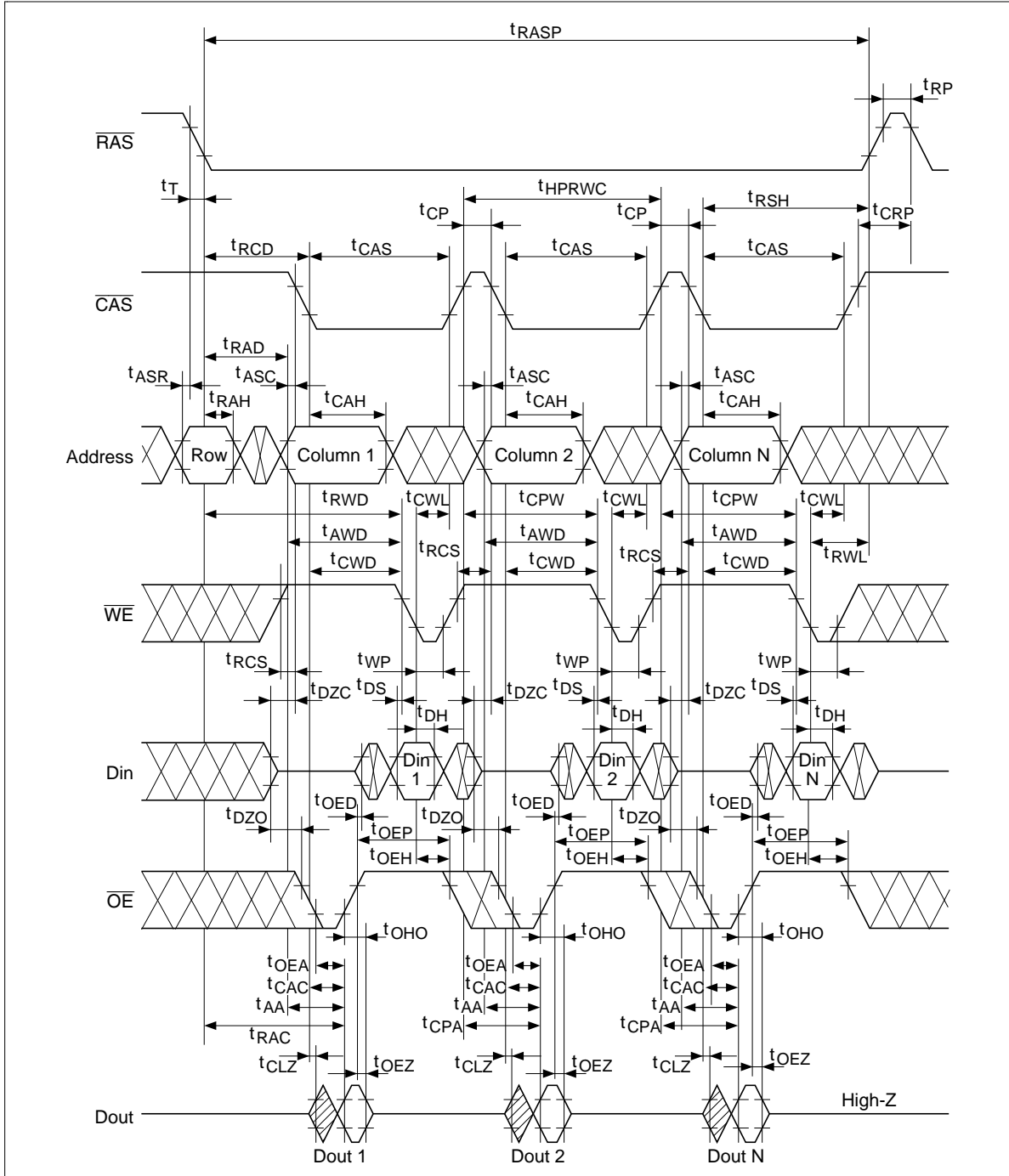
# HM5112805TD-5, HM5113805TD-5

## EDO Page Mode Delayed Write Cycle\*18



# HM5112805TD-5, HM5113805TD-5

## EDO Page Mode Read-Modify-Write Cycle\*18





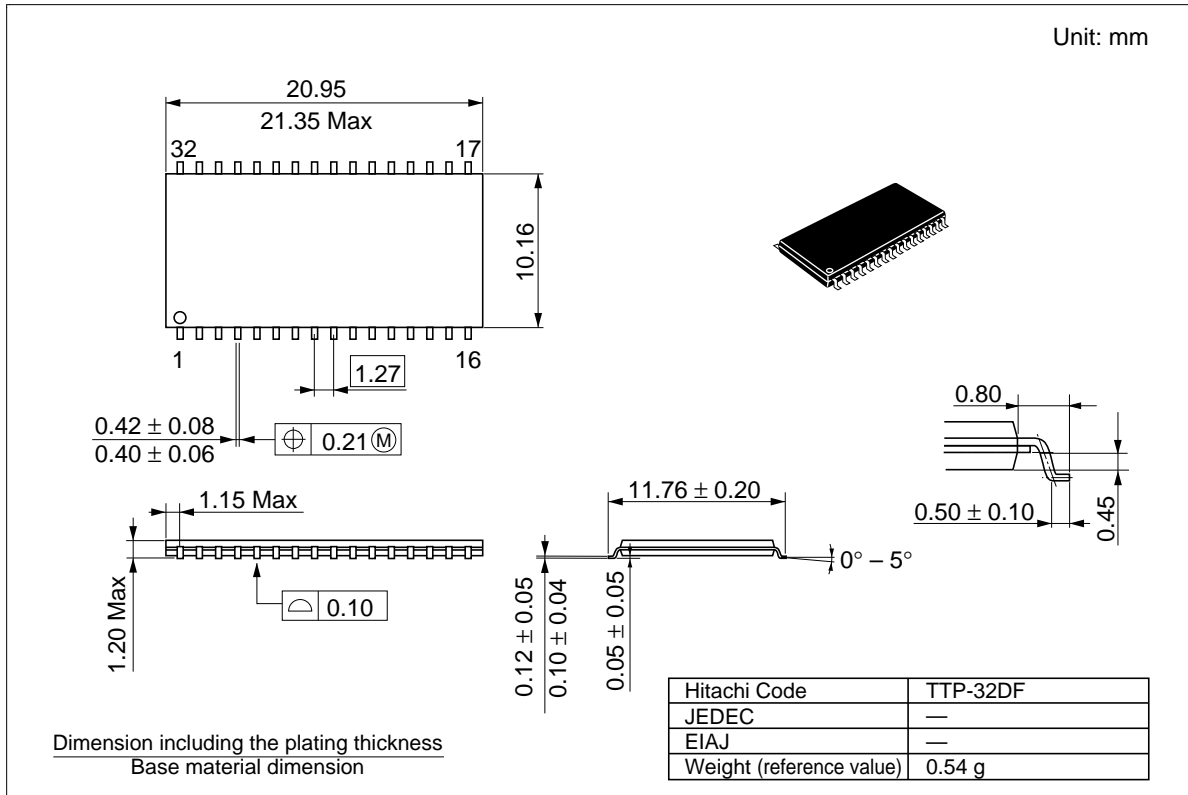


# HM5112805TD-5, HM5113805TD-5

## Package Dimensions

HM5112805TD Series

HM5113805TD Series (TTP-32DF)



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## HM5112805TD-5, HM5113805TD-5

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## HM5112805TD-5, HM5113805TD-5

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### Revision Record

Rev.	Date	Contents of Modification	Drawn by	Approved by
1.0	Jun. 22, 1998	Initial issue		